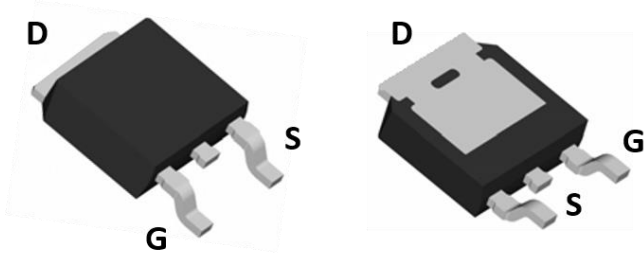
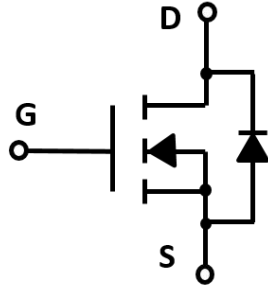


N-Channel Enhancement Mode Field Effect Transistor



TO-252



Product Summary

- V_{DS} 150V
- I_D 25A
- $R_{DS(ON)}$ (at $V_{GS}=10V$) < 75 mohm
- $R_{DS(ON)}$ (at $V_{GS}=4.5V$) < 88 mohm

General Description

- Split Gate Trench MOSFET technology
- High Speed Power Switching, logic level
- Enhanced Body diode dv/dt capability
- Enhanced Avalanche Ruggedness
- 100% UIS Tested, 100% Rg Tested

Applications

- Synchronous Rectification in SMPS
- Hard Switching and High Speed Circuit
- Power Tools
- UPS
- Motor Control

■ Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Maximum	Unit
Drain-source Voltage	V_{DS}	150	V
Gate-source Voltage	V_{GS}	± 20	V
Drain Current	I_D	$T_C=25^\circ C$	25
		$T_C=100^\circ C$	16
Pulsed Drain Current ^A	I_{DM}	90	A
Avalanche Energy, Single Pulse ^B	E_{AS}	3.75	mJ
Total Power Dissipation @ $T_C=25^\circ C$	P_D	52	W
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	2.4	$^\circ C/W$
Junction and Storage Temperature Range	T_J, T_{STG}	-55~+150	$^\circ C$

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJD25N15B	F2	YJD25N15B	2500	2500	25000	13" reel



YJD25N15B

■ Electrical Characteristics (T_J=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D =250μA	150			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =150V, V _{GS} =0V	T _J =25°C		1	μA
			T _J =100°C		100	
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =250μA	1.0	2.0	3.0	V
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =5.0A		63	75	mΩ
		V _{GS} =4.5V, I _D =4.0A		70	88	
Trans conductance	g _{fs}	V _{DS} =5V, I _D =15A		18		S
Gate Resistance	R _G	V _{GS} =0V, V _{DS} Open, f=1MHz		5.0		Ω
Diode Forward Voltage	V _{SD}	I _S =15.0A, V _{GS} =0V		0.9	1.2	V
Maximum Body-Diode Continuous Current	I _S				15.0	A
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{DS} =75V, V _{GS} =0V, f=1MHZ		625		pF
Output Capacitance	C _{oss}			37		
Reverse Transfer Capacitance	C _{rss}			13		
Switching Parameters						
Total Gate Charge (10V)	Q _g (10V)	V _{GS} =10V, V _{DD} =75V, I _D =5A		11.6		nC
Total Gate Charge (4.5V)	Q _g (4.5V)			6.5		
Gate Source Charge	Q _{gs}			1.2		
Gate Drain Charge	Q _{gd}			4		
Turn-on Delay Time	t _{d(on)}	V _{GS} =10V, V _{DD} =75V, I _D =5A, R _{GEN} =10Ω		10		ns
Turn-on Rise Time	t _r			7		
Turn-off Delay Time	t _{d(off)}			14		
Turn-off Fall Time	t _f			3		
Reverse Recovery Time	t _{rr}	V _R =75V, I _F =5A, dI _F /dt=100A/μs		50		ns
Reverse Recovery Charge	Q _{rr}			70		nC

A. Pulse Test: Pulse Width ≤ 300μs, Duty cycle ≤ 2%.

B. L=0.3mH, T_A =25°C.



■ Typical Performance Characteristics

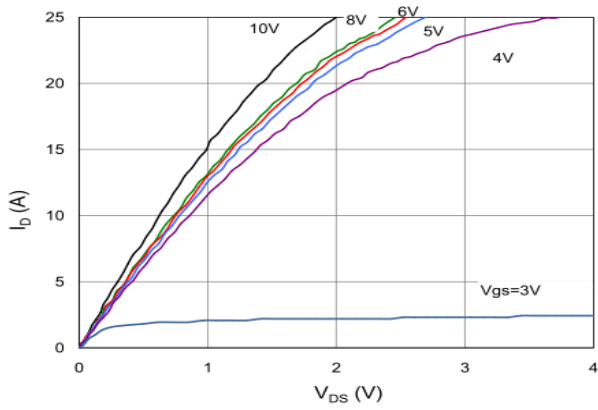


Figure1. Output Characteristics

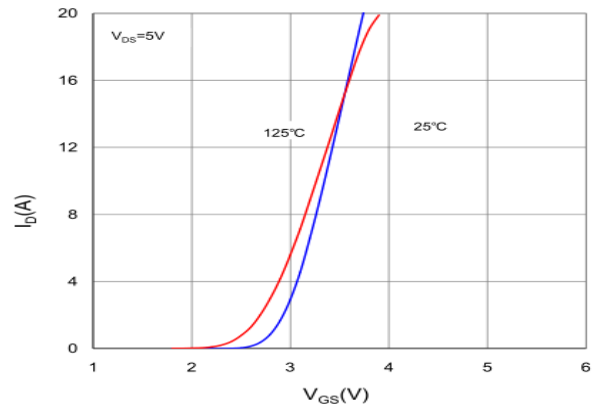


Figure2. Transfer Characteristics

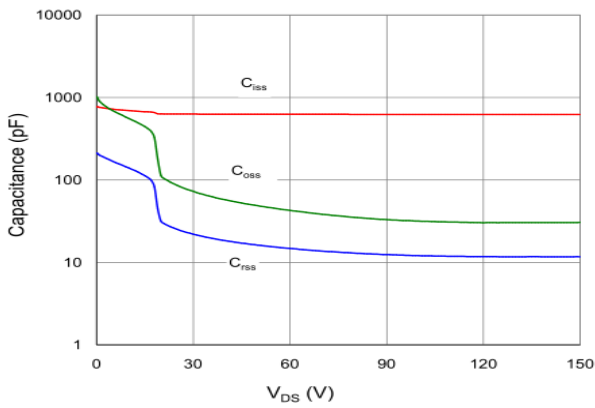


Figure3. Capacitance Characteristics

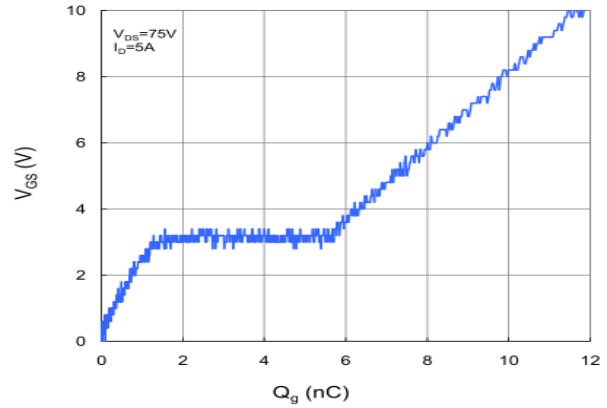


Figure4. Gate Charge

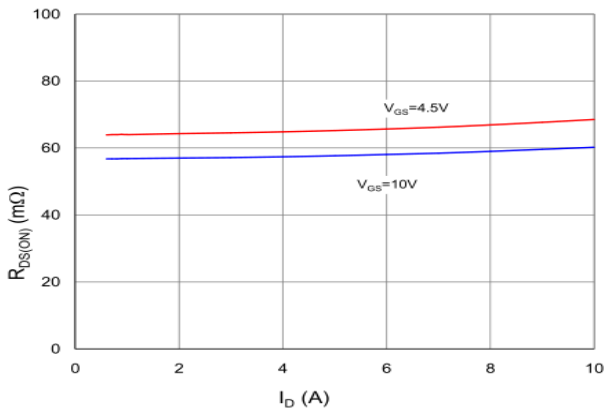


Figure5. Drain-Source on Resistance

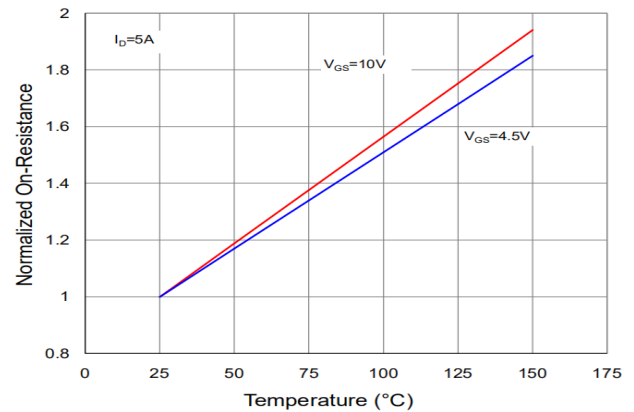


Figure6. Normalized On-Resistance vs. Junction Temperature



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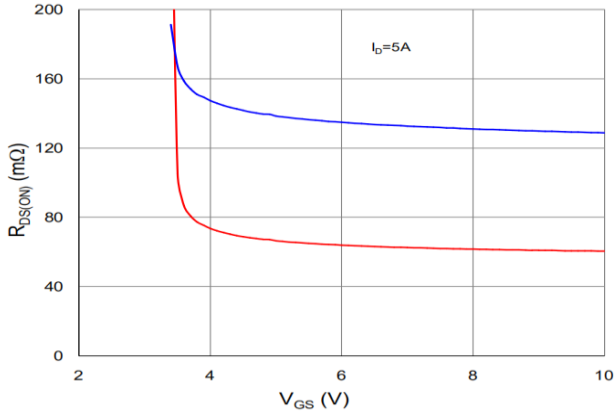


Figure7. On-Resistance vs. Gate-Source Voltage

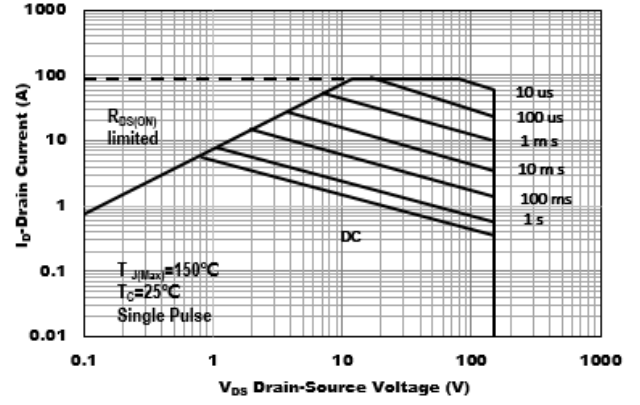


Figure8. Safe Operation Area

Figure A: Gate Charge Test Circuit & Waveforms

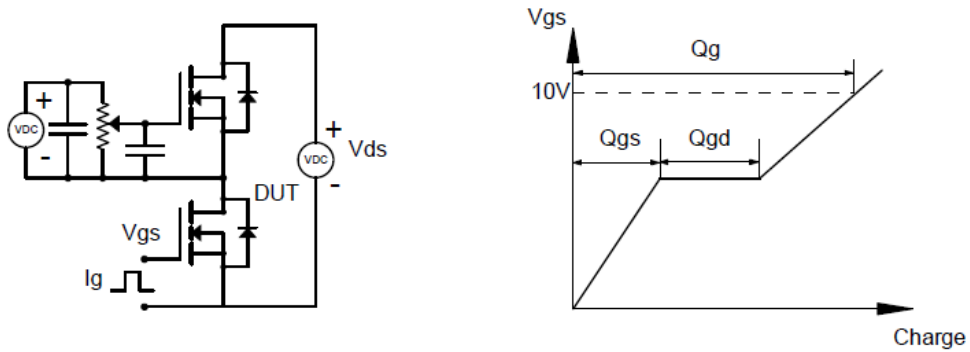


Figure B: Resistive Switching Test Circuit & Waveforms

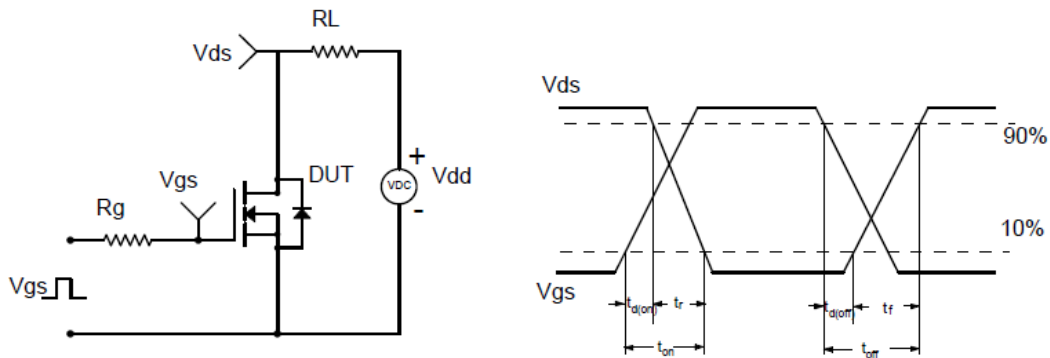


Figure C: Unclamped Inductive Switching (UIS) Test

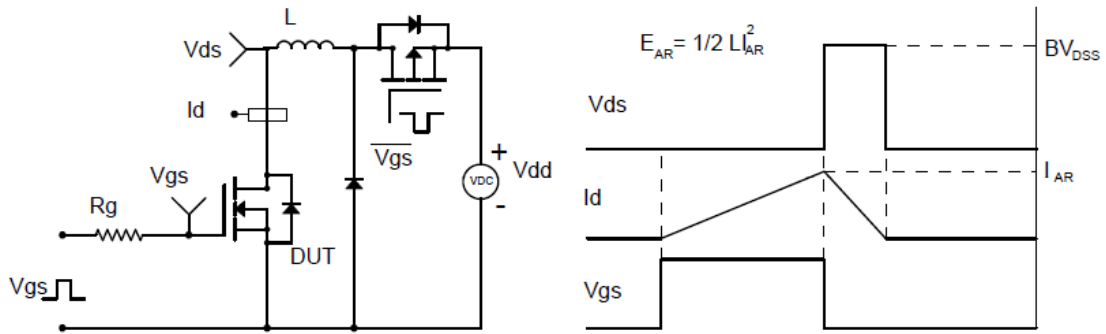
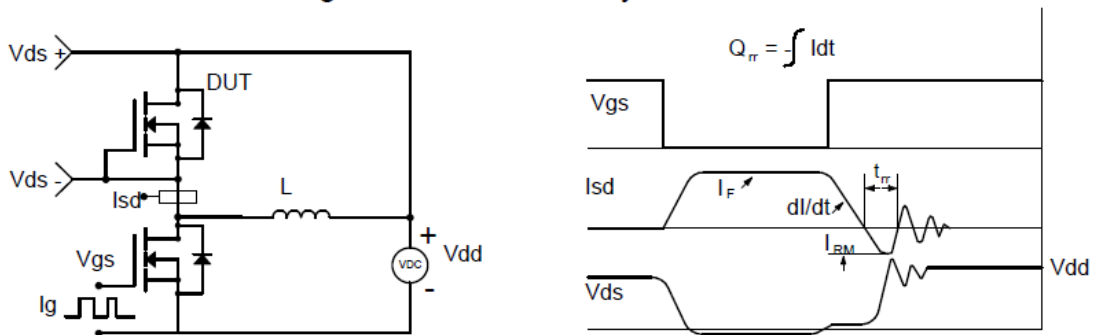


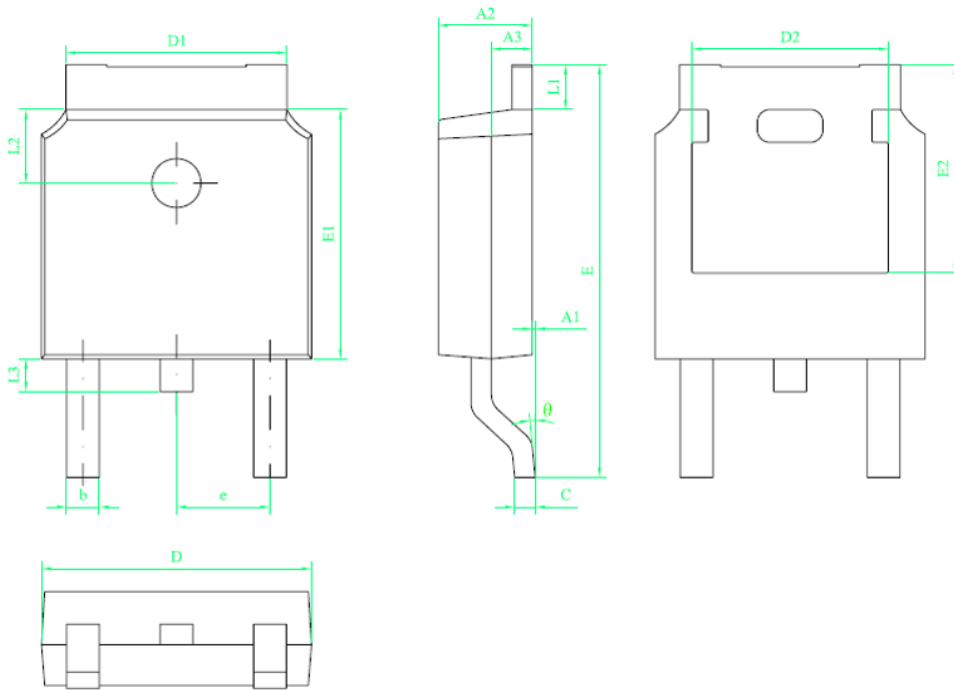
Figure D: Diode Recovery Test Circuit & Waveforms





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■TO-252 Package information



符号	尺寸		
	min	nom	max
A1	0	---	0.10
A2	2.20	2.30	2.40
A3	0.90	1.00	1.10
b	0.75	---	0.85
c	0.50	---	0.60
D	6.50	6.60	6.70
D1	5.30	5.40	5.50
D2	4.70	4.80	4.90
E	9.90	10.10	10.30
E1	6.00	6.10	6.20
E2	5.20	5.30	5.40
e	2.20	2.286	2.40
L1	0.90	---	1.25
L2	1.70	1.80	1.90
L3	0.60	0.80	1.00
θ	0°	---	8°

技术要求:

1. 树脂体不应有崩裂、缺损等缺陷;
2. 树脂上下部X、Y方向偏差不得超过0.20;
3. 胶体两端留胶总和宽度不超过0.50;
4. 所有单位为mm;



YJD25N15B

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